

O

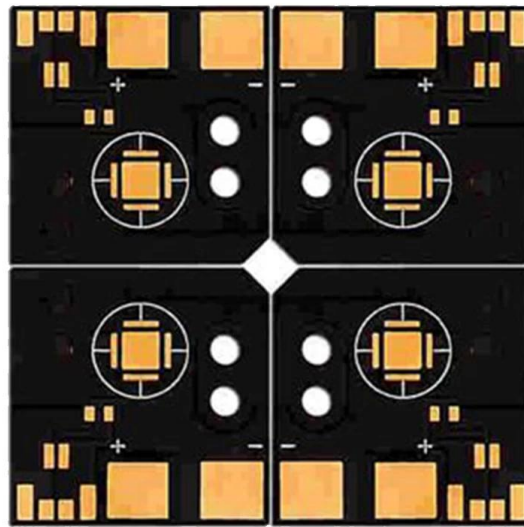
10 PCB - PCB PCB MCPCB
 - 24 S / S 48-96 4-8
 PCB

.025 AVG .020 ..

25 /

O

PCB P / N	Q501805-A
	2L
THK	0.50mm
THK	1 / 1oz
	1.6mm
	4
w / s	/
Y / N Tol	N
	Xmm 109; Ymm 50
	Xmm 109; Ymm 50; UPS 1
	N
	CNC



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PCB

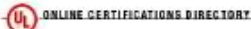
PCB







201726 201VZL430354 - Wiring, Printed - Component



ZPMV2.E490354
Wiring, Printed - Component

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Page Bottom

Wiring, Printed - Component

See General Information for Wiring, Printed - Components

O-LEADING SUPPLY CHAIN CO LIMITED

Fortune Building, Nanheng West Road
Room 1313
Huizhou, Guangdong 516211, CHINA

E490354

	Cond Width			SS/ DS/	Area Diam	Solder		Flame	RoHS	C	
	Min	Max	Min			Diper	Temp				
Min	Edge	Thk	DS/	Thk	Limits	Temp	Class	DSR	I		
Type	mm(in)	mm(in)	mil(mm)	DSO	mm(in)	C	sec	C	Class	DSR	I
Multi-layer (mass laminate) printed wiring boards.											
O-LEADING-401											
	0.2 (0.004)	0.3 (0.012)	34 (0.34)	D6	12.7 (0.5)	260	10	130	V-0	-	-
O-LEADING-407											
	0.08 (0.003)	0.2 (0.008)	17 (0.67)	D5	9.2 (0.4)	260	10	170	V-0	NI	-
Multi-layer printed wiring boards.											
O-LEADING-408											
	0.125 (0.005)	0.125 (0.005)	12 (0.47) mi-135	D6	50.8 (2.0)	260	20	130	V-0	NI	1
Single layer printed wiring boards.											
O-LEADING-002											
	0.76 (0.03)	1.14 (0.045)	34 (1.34)	S5	19.1 (0.8)	260	10	105	V-0	NI	-
O-LEADING-003											
	0.38 (0.015)	1.14 (0.045)	34 (1.34)	S5	19.1 (0.8)	260	10	130	V-0	▲	-
O-LEADING-033											
	0.15 (0.006)	0.3 (0.012)	34 (1.34)	S5	25.4 (1.0)	260	10	120	V-0	NI	-
O-LEADING-205											
	0.1 (0.004)	0.3 (0.012)	34 (1.34)	D6	69.6 (2.7)	260	10	130	V-0	NI	-
O-LEADING-206											
	0.15 (0.006)	0.33 (0.013)	17 (0.67)	D5	69.6 (2.7)	260	10	130	V-0	NI	-

* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.
Last updated on 2017-01-27

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[http://www.ul.com/ulcertification/UL60718RMS/ewg/zpmv2.e490354/Wiring,Printed-Component](#) 10



Test Report

No. CANEC1805164701

Date: 03 Apr 2018

Page 2 of 8

Test Results:

Test Part Description:

Specimen No. **SGS Sample ID** **Description**
SN1 CAN18-051647.001 Green PCB*

Remarks:

- (1) 1 mg/kg = 1 ppm = 0.0001%
- (2) MDL = Method Detection Limit
- (3) ND = Not Detected (< MDL)
- (4) "-" = Not Regulated

RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU

Test Method: With reference to IEC 62321-4:2014+A1:2017, IEC62321-5:2013, IEC62321-7-2:2017, IEC 62321-6:2015 and IEC62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

Test Item(s)	Limit	Unit	MDL	Det
Cadmium (Cd)	100	mg/kg	2	ND
Lead (Pb)	1,000	mg/kg	2	9
Mercury (Hg)	1,000	mg/kg	2	ND
Hexavalent Chromium (CrVI)	1,000	mg/kg	8	ND
Sum of PBBs	1,000	mg/kg	-	ND
Monobromobiphenyl	-	mg/kg	5	ND
Dibromobiphenyl	-	mg/kg	5	ND
Tribromobiphenyl	-	mg/kg	5	ND
Tetrabromobiphenyl	-	mg/kg	5	ND
Pentabromobiphenyl	-	mg/kg	5	ND
Hexabromobiphenyl	-	mg/kg	5	ND
Heptabromobiphenyl	-	mg/kg	5	ND
Octabromobiphenyl	-	mg/kg	5	ND
Nonabromobiphenyl	-	mg/kg	5	ND
Decabromobiphenyl	-	mg/kg	5	ND
Sum of PBDEs	1,000	mg/kg	-	ND
Monobromodiphenyl ether	-	mg/kg	5	ND
Dibromodiphenyl ether	-	mg/kg	5	ND
Tribromodiphenyl ether	-	mg/kg	5	ND
Tetrabromodiphenyl ether	-	mg/kg	5	ND
Pentabromodiphenyl ether	-	mg/kg	5	ND



SGS is pleased to announce that it has been awarded the ISO 9001:2015 certification by the Bureau Veritas Certification. This certification is a testament to the company's commitment to providing high-quality services to its customers. The certification covers the entire range of services provided by the company, from the initial consultation to the final delivery of the product. The certification is valid until 2021 and will be renewed upon successful completion of the next audit. For more information, please contact your local SGS office.

Member of the SGS Group (SGS SA)

5. PCB 制程流程图

设计 → 开料 → 钻孔 → 沉铜 → AOI → 阻焊 → 电镀 → PTH → 阻焊 → 电镀 → 钻孔 → 沉铜 → AOI → 阻焊 → 电镀 → E / T → 钻孔